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N-Channel PowerTrench[®] SyncFETTM 25 V, 130 A, 1.2 m Ω

Features

- Max $r_{DS(on)} = 1.2 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 35 \text{ A}$
- Max $r_{DS(on)} = 1.65 \text{ m}\Omega$ at $V_{GS} = 4.5 \text{ V}$, $I_D = 31 \text{ A}$
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

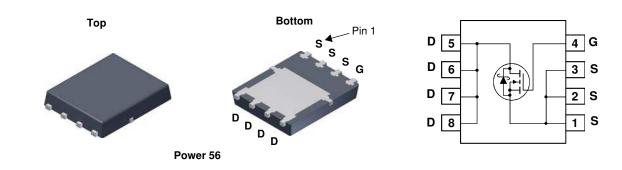


General Description

The FDMS7556S has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{DS(on)}$ while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

Applications

- Synchronous Rectifier for Synchronous Buck Converters
- Notebook
- Server
- Telecom
- High Efficiency DC-DC Switch Mode Power Supplies



MOSFET Maximum Ratings TA = 25 °C unless otherwise noted

V				Ratings	Units	
V _{DS}	Drain to Source Voltage			25	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
	Drain Current -Continuous (Package limited) T _C = 25 °C			130		
	-Continuous (Silicon limited) T _C = 25 °C			222	Α	
D	-Continuous	T _A = 25 °C	(Note 1a)	35	A	
	-Pulsed			200		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	312	mJ	
D	Power Dissipation	T _C = 25 °C		96	w	
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case	1.3	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	0/00

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7556S	FDMS7556S	Power 56	13 "	12 mm	3000 units

October 2014

FDMS7556S
N-Channel P
ower Trench
[®] SyncFET TM

$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c} BV_{DSS} & C \\ \hline \Delta BV_{DSS} & \overleftarrow{C} \\ \hline \Delta T_{J} & \overleftarrow{C} \\ I_{DSS} & \overleftarrow{C} \\ I_{GSS} & \overleftarrow{C} \\ \hline \mathbf{On \ Charact} \\ \mathbf{V}_{GS(th)} & \overleftarrow{C} \\ \hline \Delta T_{J} & \overleftarrow{T} \\ \hline \mathbf{T}_{DS(on)} & \overleftarrow{S} \\ \end{array}$	Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current, Forward Ceristics Gate to Source Threshold Voltage Gate to Source Threshold Voltage	$I_{D} = 10 \text{ mA, referenced to } 25 \text{ °C}$ $V_{DS} = 20 \text{ V, } V_{GS} = 0 \text{ V}$ $V_{GS} = 20 \text{ V, } V_{DS} = 0 \text{ V}$ $V_{GS} = V_{DS}, I_{D} = 1 \text{ mA}$				mV/°C μA
	$\begin{array}{c c} \underline{ABV}_{DSS} & E \\ \overline{\Delta T_J} & C \\ \underline{DSS} & Z \\ \underline{GSS} & C \\ \hline \begin{array}{c} Dn \ Characte \\ \overline{AGS(th)} & C \\ \overline{\Delta T_J} & T \\ \overline{DS(on)} & S \\ \end{array}$	Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current, Forward Ceristics Gate to Source Threshold Voltage Gate to Source Threshold Voltage	$I_{D} = 10 \text{ mA, referenced to } 25 \text{ °C}$ $V_{DS} = 20 \text{ V, } V_{GS} = 0 \text{ V}$ $V_{GS} = 20 \text{ V, } V_{DS} = 0 \text{ V}$ $V_{GS} = V_{DS}, I_{D} = 1 \text{ mA}$				mV/°C μA
	$\begin{array}{c c} BV_{DSS} & E \\ \overline{\Delta T_J} & C \\ DSS & Z \\ GSS & C \\ \hline \begin{array}{c} On \ Charact \\ \overline{CS(th)} & C \\ \overline{\Delta T_J} & T \\ DS(on) & S \\ \hline \end{array}$	Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current, Forward Ceristics Gate to Source Threshold Voltage Gate to Source Threshold Voltage	$I_{D} = 10 \text{ mA, referenced to } 25 \text{ °C}$ $V_{DS} = 20 \text{ V, } V_{GS} = 0 \text{ V}$ $V_{GS} = 20 \text{ V, } V_{DS} = 0 \text{ V}$ $V_{GS} = V_{DS}, I_{D} = 1 \text{ mA}$	1.2			μA
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c} & & & z \\ \hline DDSS & & Z \\ \hline GSS & & C \\ \hline \begin{array}{c} On \ Characte} \\ \hline \begin{array}{c} AV_{GS(th)} & C \\ \hline \Delta T_J & T \\ \hline DS(on) & S \\ \hline \end{array}$	Zero Gate Voltage Drain Current Gate to Source Leakage Current, Forward Ceristics Gate to Source Threshold Voltage Gate to Source Threshold Voltage	$V_{DS} = 20 V, V_{GS} = 0 V$ $V_{GS} = 20 V, V_{DS} = 0 V$ $V_{GS} = V_{DS}, I_D = 1 mA$	1.2			μA
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c} \hline GSS & C \\ \hline GSS & C \\ \hline Dn Charact \\ \hline V_{GS(th)} & C \\ \hline \Delta V_{GS(th)} & C \\ \hline \Delta T_J & T \\ \hline \sigma_{DS(on)} & S \\ \hline \end{array}$	Gate to Source Leakage Current, Forward eristics Gate to Source Threshold Voltage Gate to Source Threshold Voltage	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$ $V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.2			
A Characteristics $3S(th)$ Gate to Source Threshold Voltage $V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$ 1.21.63.0V $V_{GS(th)}$ Gate to Source Threshold Voltage $I_D = 10 \text{ mA}$, referenced to $25 ^{\circ}\text{C}$ -5mV/~C $V_{GS}(n)$ Static Drain to Source On Resistance $V_{GS} = 10 \text{ V}$, $I_D = 35 \text{ A}$ 0.951.2 $V_{GS} = 10 \text{ V}$, $I_D = 35 \text{ A}$ 0.951.2mV/~C $V_{GS} = 10 \text{ V}$, $I_D = 35 \text{ A}$ 1.31.65mΩ $V_{GS} = 10 \text{ V}$, $I_D = 35 \text{ A}$ 212S $remain Characteristics$ $V_{DS} = 5 \text{ V}$, $I_D = 35 \text{ A}$ 212S $remain Characteristics$ $V_{DS} = 13 \text{ V}$, $V_{GS} = 0 \text{ V}$, 6740 8965 pF ss Input Capacitance $V_{DS} = 13 \text{ V}$, $V_{GS} = 0 \text{ V}$, 114 475 pF ss Reverse Transfer Capacitance $f = 1 \text{ MHz}$ 314 475 pF ss Reverse Transfer Capacitance $V_{DS} = 13 \text{ V}$, $V_{GS} = 0 \text{ V}$, 918 ns $vitching Characteristics$ $v_{DD} = 13 \text{ V}$, $I_D = 35 \text{ A}$, $9 \text{ 18} \text{ ns}$ $sign Turn-Off Delay Time$ $V_{GS} = 0 \text{ V to 10 V}$ $95 \text{ 133} \text{ nC}$ $sign Turn-Off Delay Time$ $V_{GS} = 0 \text{ V to 4.5 V}$ $43 \text{ 60} \text{ nC}$ $sign Turn-Off Delay Time$ $V_{GS} = 0 \text{ V to 4.5 V}$ $43 \text{ 60} \text{ nC}$ $sign Turn-Off Delay Time$ $V_{GS} = 0 \text{ V to 4.5 V}$ $43 \text{ 60} \text{ nC}$ $sign Turn-Off Delay Time$ $V_{GS} = 0 \text{ V to 4.5 V}$ $43 \text{ 60} \text{ nC}$ $sign Turn-Off Del$	$\begin{array}{c c} \textbf{Dn Charact}\\ \hline \textbf{C}_{GS(th)} & \textbf{C}\\ \hline \Delta V_{GS(th)} & \textbf{C}\\ \hline \Delta T_J & \textbf{T}\\ \hline \textbf{D}_{S(on)} & \textbf{S} \end{array}$	Cate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.2		100	nA
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c} V_{\rm GS(th)} & {\rm C}\\ \Delta V_{\rm GS(th)} & {\rm C}\\ \Delta T_{\rm J} & {\rm T}\\ \\ DS(on) & {\rm S} \end{array}$	Gate to Source Threshold Voltage Gate to Source Threshold Voltage		1.2			
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\frac{\Delta V_{GS(th)}}{\Delta T_J} \qquad T$ $r_{DS(on)} \qquad S$	Gate to Source Threshold Voltage		1.2	10		
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\frac{\Delta V_{GS(th)}}{\Delta T_J} \qquad T$ $r_{DS(on)} \qquad S$	•			1.6	3.0	V
	20(01)				-5		mV/°C
	20(01)		V _{GS} = 10 V, I _D = 35 A		0.95	1.2	
V _{GS} = 10 V, I _D = 35 A, T _J = 125 °C 1.2 1.6 S Forward Transconductance V _{DS} = 5 V, I _D = 35 A 212 S Input Capacitance V _{DS} = 5 V, I _D = 35 A 212 S Input Capacitance V _{DS} = 13 V, V _{GS} = 0 V, f = 1 MHz 6740 8965 pF Input Capacitance V _{DS} = 13 V, V _{GS} = 0 V, f = 1 MHz 1940 2580 pF Input Capacitance I		Static Drain to Source On Resistance			1.3	1.65	mΩ
sForward Transconductance $V_{DS} = 5 \text{ V}, \text{ I}_{D} = 35 \text{ A}$ 212S/namic CharacteristicsssInput Capacitance $V_{DS} = 13 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$ $6740 8965 pF$ ssOutput Capacitance $f = 1 \text{ MHz}$ $314 475 pF$ aGate Resistance $0.6 1.3 \Omega$ vitching Characteristicson)Turn-On Delay TimeRise Time $V_{DD} = 13 \text{ V}, \text{ I}_D = 35 \text{ A}, \text{ V}_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ off)Turn-Off Delay Time $488 77 ns$ aTotal Gate Charge $V_{GS} = 0 \text{ V to } 4.5 \text{ V}, \text{ V}_{DD} = 13 \text{ V}, \text{ I}_D = 35 \text{ A}, \text{ V}_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ aTotal Gate Charge $V_{GS} = 0 \text{ V to } 4.5 \text{ V}, \text{ V}_{DD} = 13 \text{ V}, \text{ I}_D = 35 \text{ A}, \text{ I}$	-		V _{GS} = 10 V, I _D = 35 A, T _J = 125 °C		1.2	1.6	-
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	g _{FS} F	Forward Transconductance			212		S
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Dynamic Cl	haracteristics			+		
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Fall Time5.311nsTotal Gate Charge $V_{GS} = 0 \vee to 10 \vee$ 95133nCTotal Gate Charge $V_{GS} = 0 \vee to 4.5 \vee$ $V_{DD} = 13 \vee$ 4360nCgsGate to Source Gate Charge $I_D = 35 \wedge$ 18.6nCgdGate to Drain "Miller" Charge8.8nC	1				-		
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	a(o)	-	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		-		ns
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Js Gate to Source Gate Charge ID = 35 Å 18.6 nC Jd Gate to Drain "Miller" Charge 8.8 nC	9		$V_{GS} = 0 V$ to 10 V			133	nC
Instruction Instruction Image Image Ima	9	-				60	nC
ain-Source Diode Characteristics	90		I _D = 35 A		18.6		nC
	Q _{gd}	Sate to Drain "Miller" Charge			8.8		nC
$V_{\text{res}} = 0 V \downarrow 1 = 0 \text{ A} \qquad (\text{Note } 0) \qquad 0.027 \qquad 0.7$	Drain-Sourc	ce Diode Characteristics					
Source to Drain Diode Forward Voltage $V_{GS} = 0.7, I_S = 2.4$ (Note 2) 0.37 0.7 V		Source to Drain Diade, Ecoward Valtage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.37	0.7	V
D Source to Drain Diode Forward Voltage		source to Drain Diode Forward voltage	$V_{GS} = 0 V, I_S = 35 A$ (Note 2)		0.74	1.2	v
V _{GS} = 0 V, I _S = 35 A (Note 2) 0.74 1.2	V _{SD} S				4.4		
VGS = 0 V, IS = 35 A (Note 2) 0.74 1.2 Beverse Becovery Time 44 71 ns		Reverse Recovery Time	I 35 A di/dt _ 300 A/us		44	71	ns
	Q _g T Q _g T Q _{gs} C Q _{gd} C Drain-Source	Total Gate Charge Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge Ce Diode Characteristics	$V_{GS} = 0 V \text{ to } 4.5 V$ $I_D = 35 A$ $V_{GS} = 0 V, I_S = 2 A$ (Note 2)		95 43 18.6 8.8 0.37		133 60 0.7
$v_{GS} = 0 V, I_S = 35 A$ (Note 2) 0.74 1.2	/ _{SD}				4.4	71	
V _{GS} = 0 V, I _S = 35 A (NOLE 2) 0.74 1.2	F	Reverse Recovery Time	$I_{\rm r} = 35 \Delta di/dt = 300 \Delta/uc$		44	71	ns





2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

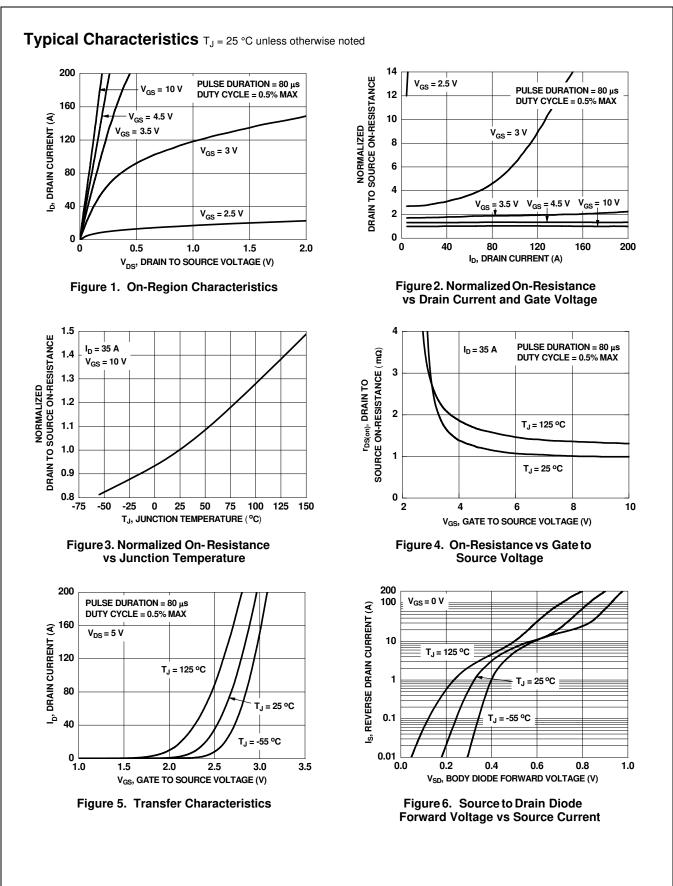
3. E_{AS} of 312 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 25 A, V_{DD} = 23 V, V_{GS} = 10 V. 100% test at L = 0.3 mH, I_{AS} = 38 A.

4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

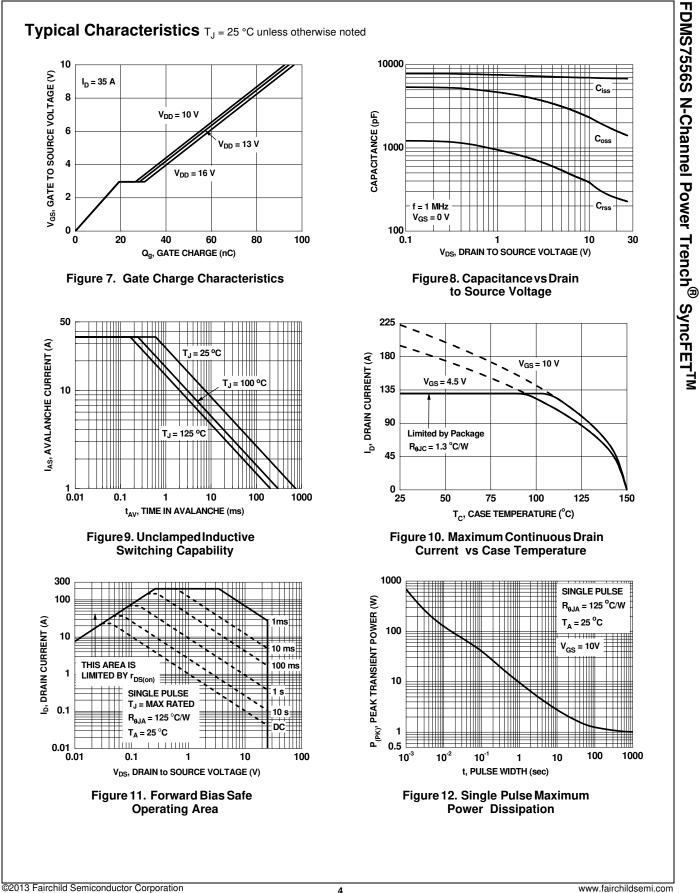
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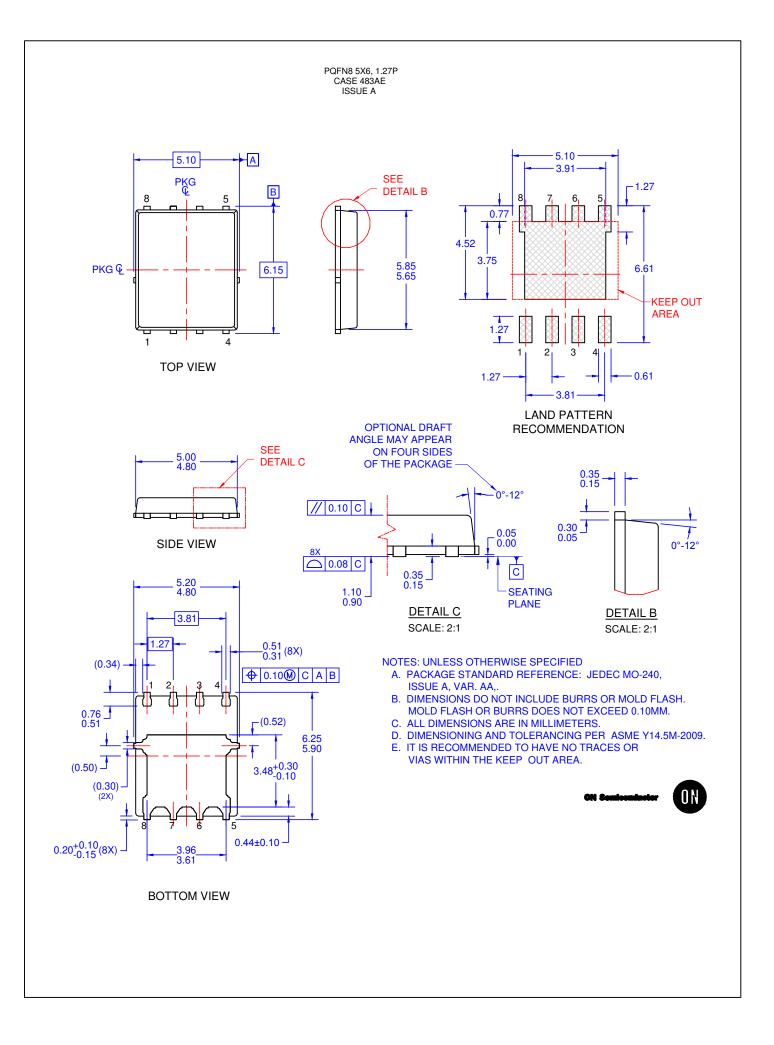
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FDMS7556S Rev.C4



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